20 V, 5 A, Low V_{CE(sat)} **PNP** Transistor

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

MAXIMUM RATINGS (T_A = 25°C)

| Rating | Symbol | Max | Unit |
|--------------------------------|------------------|----------------------------|------|
| Collector-Emitter Voltage | V _{CEO} | -20 | Vdc |
| Collector-Base Voltage | V _{CBO} | -30 | Vdc |
| Emitter-Base Voltage | V _{EBO} | -6.0 | Vdc |
| Collector Current – Continuous | Ι _C | -3.0 | Adc |
| Collector Current – Peak | I _{CM} | -5.0 | А |
| Electrostatic Discharge | ESD | HBM Class 3B MM Class C | |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|--|----------------|--------------|
| Total Device Dissipation, T _A = 25°C Derate above 25°C | P _D (Note 1) | 545 4.3 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ (Note 1) | 230 | °C/W |
| Total Device Dissipation $T_A = 25^{\circ}C$ | P _D (Note 2) | 1.06 | W |
| Derate above 25°C | | 8.5 | mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ (Note 2) | 118 | °C/W |
| Thermal Resistance, Junction-to-Lead #1 | R _{θJL} (Note 1) R _{θJL} (Note 2) | 48 40 | °C/W °C/W |
| Total Device Dissipation (Single Pulse < 10 sec.) | P _{Dsingle} (Note 2) | 1.75 | W |
| Junction and Storage Temperature Range | T _J , T _{stg} | –55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

FR-4 @ 100 mm², 2 oz copper traces.
FR-4 @ 500 mm², 2 oz copper traces.



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20 VOLTS **5.0 AMPS** $\begin{array}{c} \text{PNP LOW V}_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \text{EQUIVALENT R}_{\text{DS(on)}} \text{ 78 m} \Omega \end{array}$





TSOP-6 **CASE 318G** STYLE 6

DEVICE MARKING



VS1 = Specific Device Code

- = Date Code Μ
 - = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| | Device | Package | Shipping [†] |
|---|----------------|---------------------|-----------------------|
| Ν | NSS20300MR6T1G | TSOP-6 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25° C unless otherwise noted)

| Characteristic | Symbol | Min | Typical | Max | Unit |
|---|----------------------|-------------------|----------------------------|----------------------------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$ | V _{(BR)CEO} | -20 | | - | Vdc |
| Collector – Base Breakdown Voltage $(I_C = -0.1 \text{ mAdc}, I_E = 0)$ | V _{(BR)CBO} | -30 | | - | Vdc |
| Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$ | V _{(BR)EBO} | -6.0 | | - | Vdc |
| Collector Cutoff Current ($V_{CB} = -20 \text{ Vdc}, I_E = 0$) | I _{CBO} | _ | | -0.1 | μAdc |
| Collector–Emitter Cutoff Current (V _{CES} = -20 Vdc) | ICES | _ | | -0.1 | μAdc |
| Emitter Cutoff Current (V _{EB} = -6.0 Vdc) | I _{EBO} | _ | | -0.1 | μAdc |
| ON CHARACTERISTICS | | | | | |
| DC Current Gain ⁽¹⁾ ($I_C = -1.0 \text{ A}, V_{CE} = -1.5 \text{ V}$) ($I_C = -1.5 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) | h _{FE} | 100 100 100 | 230 | _ 400 _ | |
| Collector – Emitter Saturation Voltage (Note 3) ($I_C = -0.10 \text{ A}, I_B = -0.010 \text{ A}$) ($I_C = -1.0 \text{ A}, I_B = -0.010 \text{ A}$) ($I_C = -2.0 \text{ A}, I_B = -0.02 \text{ A}$) | V _{CE(sat)} | - - - | -0.010 -0.127 -0.250 | -0.015 -0.145 -0.320 | V |
| Base – Emitter Saturation Voltage (Note 3) $(I_{C} = -1A, I_{B} = -0.010 A)$ | V _{BE(sat)} | _ | _ | -0.85 | V |
| Base – Emitter Turn-on Voltage (Note 3) (I _C = -2.0 A, V _{CE} = -3.0 V) | V _{BE(on)} | _ | _ | -0.875 | V |
| Cutoff Frequency (I _C = -100 mA, V _{CE} = -5.0 V, f = 100 MHz) | f _T | 100 | _ | - | MHz |
| Input Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz) | C _{IBO} | - | | 650 | pF |
| Output Capacitance (V _{CB} = -3.0 V, f = 1.0 MHz) | C _{OBO} | - | | 100 | pF |

3. Pulsed Condition: Pulse Width \leq 300 µsec, Duty Cycle \leq 2%.





V_{CB}, COLLECTOR BASE VOLTAGE (V) Figure 9. NSS20300MR6T1G Output Capacitance





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